NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE0130K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

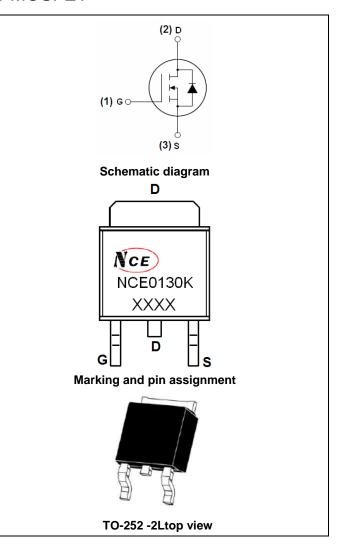
- V_{DS} = 100V, I_{D} =30A $R_{DS(ON)}$ < 28mΩ @ V_{GS} =10V (Typ:24mΩ)
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking and Ordering Information

-			<u> </u>					
	Device Marking	Device	Device Package	Reel Size	Tape width	Quantity		
ſ	NCE0130K	NCE0130K	TO-252-2L	-	-	-		

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage	100	V
V _G s	Gate-Source Voltage	±20	V
I _D	Drain Current-Continuous	30	Α
I _D (100℃)	Drain Current-Continuous(TC=100℃)	21	Α
I _{DM}	Pulsed Drain Current	70	Α
P _D	Maximum Power Dissipation	85	W
	Derating factor	0.57	W/℃
E _{AS}	Single pulse avalanche energy (Note 5)	256	mJ
T_{J}, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 175	$^{\circ}$ C



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NCE0130K

Thermal Characteristic

R _{0JC} Thermal Resistance, Junction-to-Case (Note 2) 1.8	/W
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Electrical Characteristics (T_C=25°C unless otherwise noted)

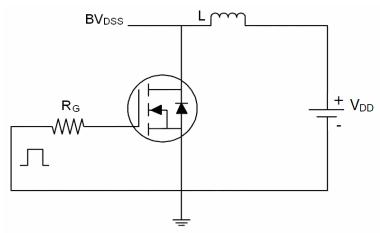
	Symbol Parame	eter	Condition	Min	Тур	Max	Unit
Off Characteris	etics	•					
BV _{DSS}	Drain-Source Breakdown Volta	age	V _{GS} =0V I _D =250μA	100	110	-	V
I _{DSS}	Zero Gate Voltage Drain Curre	ent	V _{DS} =100V,V _{GS} =0V	-	-	1	μΑ
I _{GSS}	Gate-Body Leakage Current		V _{GS} =±20V,V _{DS} =0V -		-	±100	nA
On Characteris	tics (Note 3)	•		•			
$V_{GS(th)}$	Gate Threshold Voltage		$V_{DS}=V_{GS}$, $I_{D}=250\mu A$		3	4	V
R _{DS(ON)}	Drain-Source On-State Resista	nce	V _{GS} =10V, I _D =15A	-	24	28	mΩ
g FS	Forward Transconductance		V _{DS} =5V,I _D =10A	-	15	-	S
Dynamic Chara	acteristics (Note4)	<u> </u>					
C _{lss}	Input Capacitance		\\ O5\\\\	-	2000	-	PF
Coss	Output Capacitance		V_{DS} =25V, V_{GS} =0V,	-	300	-	PF
C _{rss}	Reverse Transfer Capacitano	е	F=1.0MHz	-	250	-	PF
Switching Cha	racteristics (Note 4)	<u> </u>					
t _{d(on)}	Turn-on Delay Time			-	7	-	nS
t _r	Turn-on Rise Time		V_{DD} =50 V , R_L =5 Ω	-	7	-	nS
$t_{d(off)}$	Turn-Off Delay Time		V_{GS} =10V, R_{GEN} =3 Ω	-	29	-	nS
t _f	Turn-Off Fall Time			-	7	-	nS
Qg	Total Gate Charge)/ F0)/ 40A	-	39	-	nC
Q _{gs}	Gate-Source Charge		$V_{DS}=50V, I_{D}=18A,$	-	8	-	nC
Q_{gd}	Gate-Drain Charge		V _{GS} =10V	-	12	-	nC
Drain-Source [Diode Characteristics	•		•	•		
V _{SD}	Diode Forward Voltage (Note 3	3)	V _{GS} =0V,I _S =20A	-	-	1.2	V
Is	Diode Forward Current (Note 2		-	-	-	30	Α
t _{rr}	Reverse Recovery Time		TJ = 25°C, IF = 18A	-	32	-	nS
Qrr	Reverse Recovery Charge		$di/dt = 100A/\mu s^{(Note3)}$	-	53	-	nC
t _{on}	Forward Turn-On Time		Intrinsic turn-on time is negl	igible (turr	n-on is do	minated b	y LS+LD)

Notes:

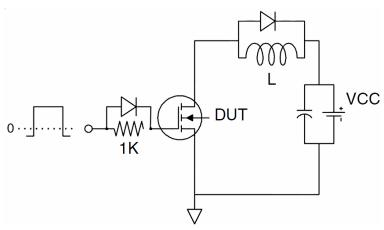
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS Condition : Tj=25 $^{\circ}$ C,V_{DD}=50V,V_G=10V,L=0.5mH,Rg=25 Ω , I_{AS}=32A

Test Circuit

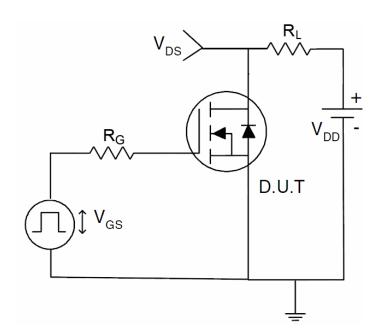
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

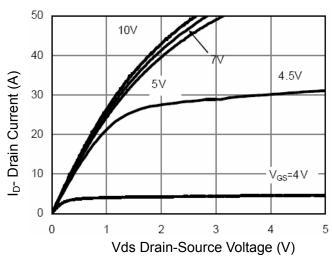


Figure 1 Output Characteristics

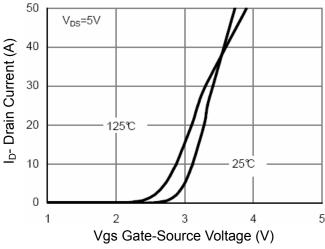


Figure 2 Transfer Characteristics

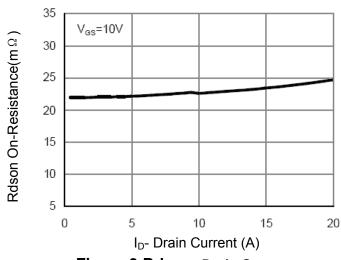


Figure 3 Rdson- Drain Current

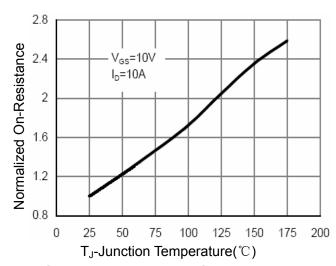


Figure 4 Rdson-JunctionTemperature

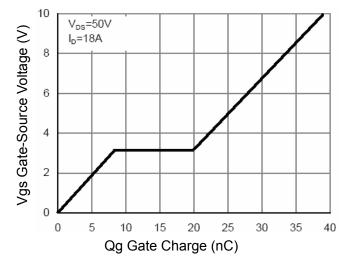


Figure 5 Gate Charge

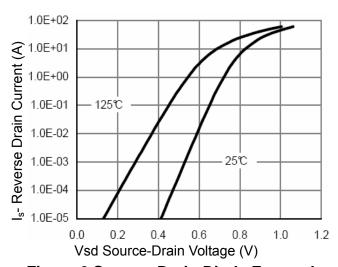


Figure 6 Source- Drain Diode Forward



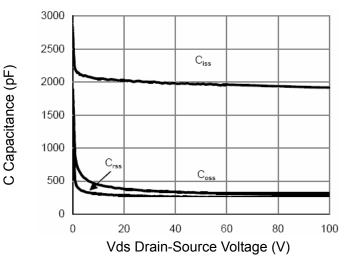


Figure 7 Capacitance vs Vds

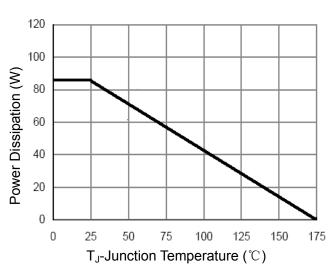


Figure 9 Power De-rating

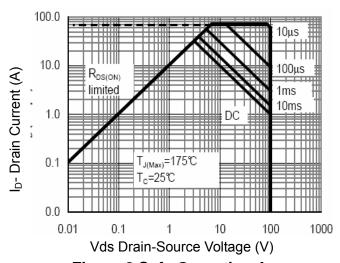


Figure 8 Safe Operation Area

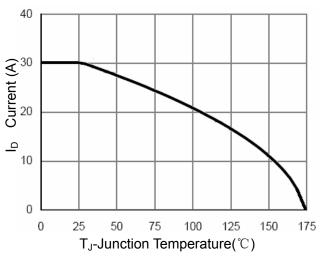


Figure 10ID Current- Junction Temperature

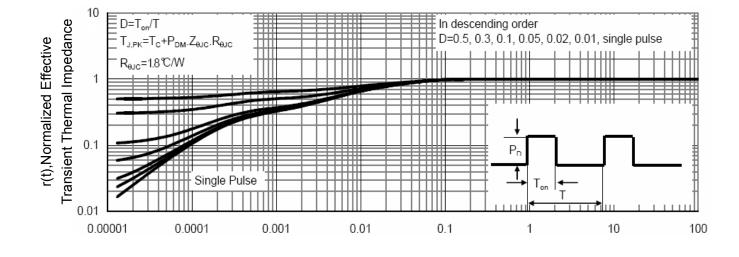
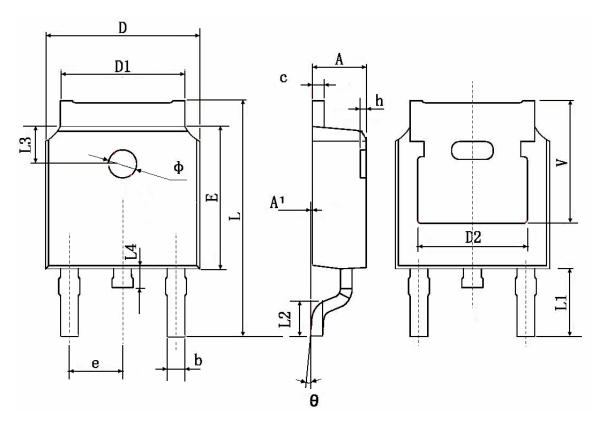


Figure 11 Normalized Maximum Transient Thermal Impedance

Square Wave Pluse Duration(sec)



TO-252 Package Information



Comple of	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	0.48	3 TYP.	0.190 TYP.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900 TYP.		0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600 TYP.		0.063 TYP.		
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.35	0 TYP.	0.211 TYP.		



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NCE0130K

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